

Title (en)

A method for treating contact leads on electrochemical cells so as to achieve improved hermeticity and hermetically sealed electrochemical cells derived therefrom.

Title (de)

Methode zur Behandlung von Kontaktanschlüssen an elektrochemischen Zellen, zur Erzielung verbesserter Dichtheit, und hermetisch verschlossene elektrochemische Zellen die damit hergestellt sind

Title (fr)

Une méthode pour traiter les fiches de contact de cellules électrochimiques pour obtenir 1 herméticité accrue et cellules électrochimiques hermétiquement scellées

Publication

EP 1039563 A1 20000927 (EN)

Application

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Priority

US 12563899 P 19990322

Abstract (en)

The present invention provides a method of hermetically sealing an electrochemical cell (10). In the disclosed method, a coating of an adhesive composition is applied to an external metal tab (30, 30<1>) that serves as a contact lead from the cell (10) to a device within which the cell (10) is employed. The adhesive coats and hermetically seals the tab surface thereby. The coating process can be executed by directly heat-sealing an adhesive film onto the tab surface. Alternatively, an aqueous suspension of the adhesive composition can be sprayed onto the tab surface, or the tab may be roll coated in the composition and thereafter subjected to heat treatment, causing the adhesive to melt and flow. The coated tab (30, 30<1>) is thereafter welded to a corresponding current collector in the form of a metal foil. The complete cell assembly (10) is heat-sealed in a final closure sealing member (16) such that the sealed tabs (30, 30<1>) extend therethrough. <IMAGE>

IPC 1-7

H01M 2/02; **H01M 2/06**; **H01M 2/26**

IPC 8 full level

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CPC (source: EP US)

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